IGBT - Field Stop

600 V, 40 A

FGH80N60FD2

Description

Using novel field stop IGBT technology, ON Semiconductor's field stop IGBTs offer the optimum performance for induction heating and PFC applications where low conduction and switching losses are essential.

Features

- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.8 \text{ V} (Typ.) @ I_C = 40 \text{ A}$
- High Input Impedance
- Fast Switching
- This Device is Pb-Free and is RoHS Compliant

Applications

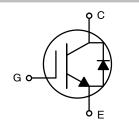
• Induction Heating, PFC

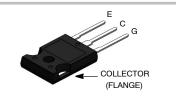


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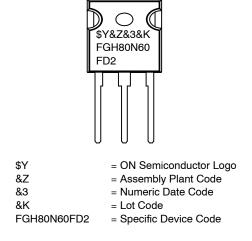
V _{CES}	Ι _C
600 V	40 A





TO-247-3LD CASE 340CK

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

Symbol	Description		Ratings	Unit
V _{CES}	Collector to Emitter Voltage		600	V
V _{GES}	Gate-Emitter Voltage		±20	V
Ι _C	Collector Current	$T_{\rm C} = 25^{\circ}{\rm C}$	80	А
		T _C = 100°C	40	А
I _{CM} (Note 1)	Pulsed Collector Current	$T_{\rm C} = 25^{\circ}{\rm C}$	160	А
PD	Maximum Power Dissipation	T _C = 25°C	290	W
		$T_C = 100^{\circ}C$	116	W
TJ	Operating Junction Temperature	•	-55 to +150	°C
T _{STG}	Storage Temperature Range		-55 to +150	°C
ΤL	Maximum Lead Temp. for Soldering Purp	coses, 1/8" from Case for 5 Seconds	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case	-	0.43	°C/W
$R_{\theta JA}$ (Diode)	Thermal Resistance, Junction to Case	-	1.45	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	-	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGH80N60FD2TU	FGH80N60FD2	TO-247	Tube	N/A	N/A	30

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit		
OFF CHARACT	OFF CHARACTERISTICS							
BV _{CES}	Collector-Emitter Breakdown Voltage	V_{GE} = 0 V, I _C = 250 μ A	600	-	-	V		
$\Delta \text{BV}_{\text{CES}}/\Delta\text{T}_{\text{J}}$	Temperature Coefficient of Breakdown Voltage	V_{GE} = 0 V, I _C = 250 μ A	-	0.6	-	V/°C		
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μΑ		
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA		
ON CHARACTE	RISTICS							
14			4.5					

V _{GE(th)}	G-E Threshold Voltage	$I_C = 250 \ \mu A, \ V_{CE} = V_{GE}$	4.5	5.5	7.0	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C = 40 A, V _{GE} = 15 V,	-	1.8	2.4	V
		I _C = 40 A, V _{GE} = 15 V, T _C = 125°C	-	2.05	-	V

DYNAMIC CHARACTERISTICS

C _{ies}	Input Capacitance	V _{CE} = 30 V, V _{GE} = 0 V, f = 1 MHz	-	2110	-	pF
C _{oes}	Output Capacitance	1 - 1 101112	-	200	-	pF
C _{res}	Reverse Transfer Capacitance		-	60	-	pF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
	HARACTERISTICS		-	-	•	-
T _{d(on)}	Turn–On Delay Time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A},$	-	21	-	ns
Tr	Rise Time	$R_G = 10 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25^{\circ}C$	-	56	-	ns
T _{d(off)}	Turn-Off Delay Time		-	126	-	ns
Tf	Fall Time		-	50	100	ns
Eon	Turn-On Switching Loss		-	1	1.5	mJ
E _{off}	Turn-Off Switching Loss		-	0.52	0.78	mJ
E _{ts}	Total Switching Loss		-	1.52	2.28	mJ
T _{d(on)}	Turn–On Delay Time	$V_{CC} = 400 \text{ V}, I_C = 40 \text{ A},$	-	20	-	ns
Tr	Rise Time	$R_G = 10 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 125$ °C	-	54	-	ns
T _{d(off)}	Turn-Off Delay Time		-	131	-	ns
T _f	Fall Time		-	70	-	ns
Eon	Turn-On Switching Loss		-	1.1	-	mJ
E _{off}	Turn-Off Switching Loss		-	0.78	-	mJ
E _{ts}	Total Switching Loss		-	1.88	-	mJ
Qg	Total Gate Charge	$V_{CE} = 400 \text{ V}, I_{C} = 40 \text{ A},$	-	120	-	nC
Q _{ge}	Gate-Emitter Charge	V _{GE} = 15 V	-	14	-	nC
Q _{gc}	Gate-Collector Charge		_	58	_	nC

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted) (continued)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ELECTRICAL CHARACTERISTICS OF THE DIODE ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Co	nditions	Min	Тур	Max	Unit
V_{FM}	Diode Forward Voltage	I _F = 15 A	$T_{C} = 25^{\circ}C$	-	1.2	1.5	V
			T _C = 125°C	-	1.0	-	
T _{rr}	Diode Reverse Recovery Time	I _F = 15 A, di _F /dt = 200 A/μs	$T_{C} = 25^{\circ}C$	-	61	-	ns
			T _C = 125°C	-	125	-	
l _{rr}	Diode Reverse Recovery Current		T _C = 25°C	-	4.8	-	А
			T _C = 125°C	-	8.4	-	
Q _{rr}	Diode Reverse Recovery Charge		$T_{C} = 25^{\circ}C$	-	146	-	nC
			T _C = 125°C	-	525	-	1

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

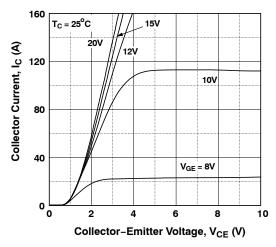


Figure 1. Typical Output Characteristics

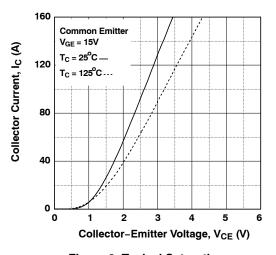
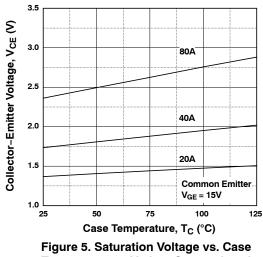
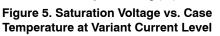


Figure 3. Typical Saturation **Voltage Characteristics**





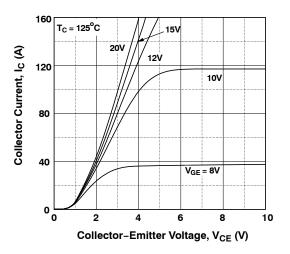


Figure 2. Typical Saturation Voltage Characteristics

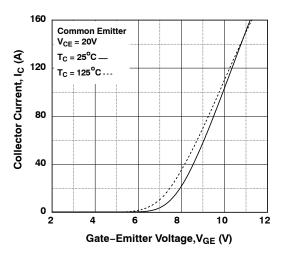


Figure 4. Transfer Characteristics

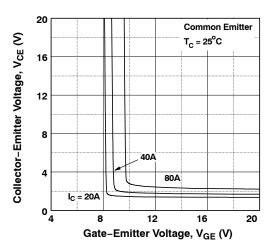


Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

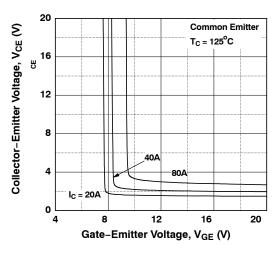


Figure 7. Saturation Voltage vs. V_{GE}

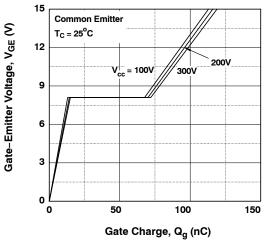
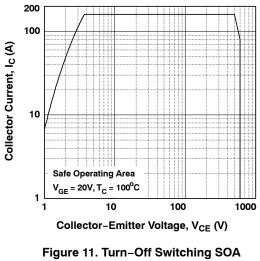


Figure 9. Gate Charge Characteristics





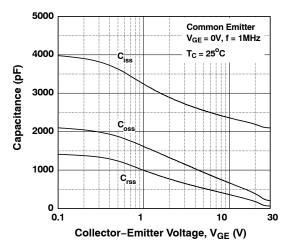


Figure 8. Capacitance Characteristics

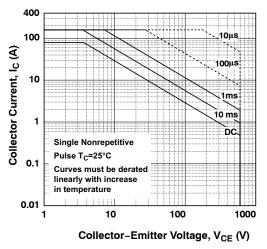
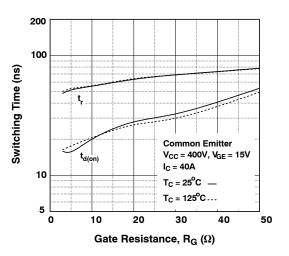
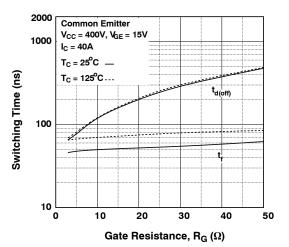


Figure 10. SOA Characteristics

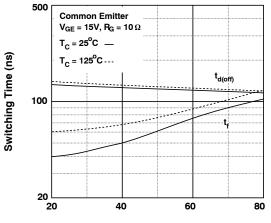




TYPICAL PERFORMANCE CHARACTERISTICS (Continued)







Collector Current, I_C (A)

Figure 15. Turn–Off Characteristics vs. Collector Current

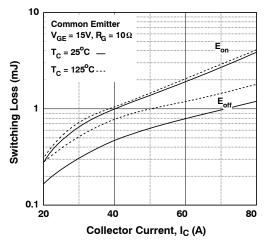


Figure 17. Switching Loss vs. Collector Current

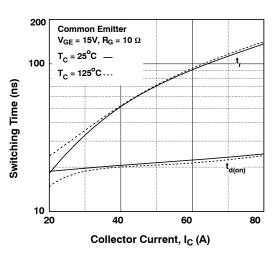


Figure 14. Turn-On Characteristics vs. Collector Current

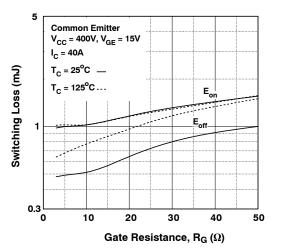
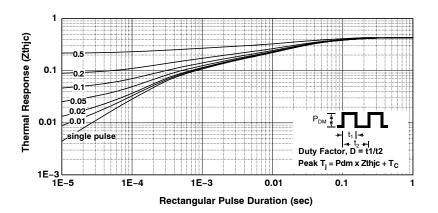


Figure 16. Switching Loss vs. Gate Resistance

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





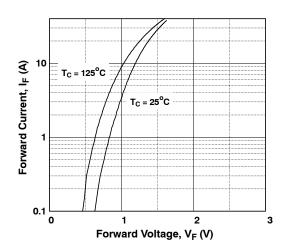


Figure 18. Forward Characteristics

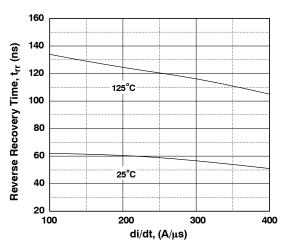
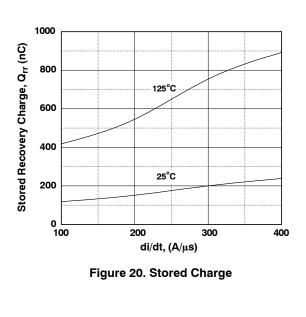


Figure 21. Reverse Recovery Time



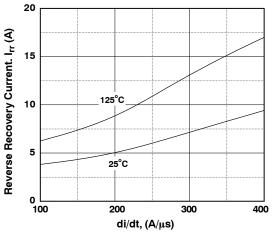


Figure 22. Reverse Recovery Current





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